

DIN-Power E048FP-11,5C1-2



Part number	09 05 248 6851	
Specification	DIN-Power E048FP-11,5C1-2	
HARTING eCatalogue	https://b2b.harting.com/09052486851	

Image is for illustration purposes only. Please refer to product description.

Identification

Category	Connectors
Series	DIN 41612
Identification	Type E
Element	Female connector
Description of the contact	Straight
Features	lead-free

Version

Termination method	Press-in termination Wrap termination	
Connection type	Motherboard to daughtercard Mezzanine	
Number of contacts	48	
Contact configuration	Rows a, c and e, positions 2, 4, , 30, 32	
Termination length	11.5 mm	
Coding	Hole coding Coding with loss of contacts	
PCB fixing	With fixing flange	

Technical characteristics

Contact rows	3
Contact spacing (termination side)	5.08 mm 5.08 mm
Contact spacing (mating side)	5.08 mm 5.08 mm



Technical characteristics

Rated current	6 A	
Rated current	Rated current measured at 20 °C, see derating curve for details	
Clearance distance	≥3 mm	
Creepage distance	≥3 mm	
Insulation resistance	>10 ¹² Ω	
Contact resistance	≤15 mΩ	
Limiting temperature	-40 +105 °C upper limiting temperature limited by the pcb	
Insertion and withdrawal force	≤75 N	
Performance level	2 acc. to IEC 60603-2	
Mating cycles	≥400	
Test voltage U _{r.m.s.}	1.55 kV	
Isolation group	IIIa (175 ≤ CTI < 400)	
PCB thickness	≥1.6 mm	
Hot plugging	No	

Material properties

Material (insert)	Thermoplastic resin, glass-fibre filled	
Colour (insert)	RAL 7032 (pebble grey)	
Material (contacts)	Copper alloy	
Surface (contacts)	Noble metal over Ni Mating side Ni Termination side	
Material flammability class acc. to UL 94	V-0	
RoHS	compliant	
ELV status	compliant	
China RoHS	е	
REACH Annex XVII substances	Not contained	
REACH ANNEX XIV substances	Not contained	
REACH SVHC substances	Not contained	
California Proposition 65 substances	Yes	
California Proposition 65 substances	Antimony trioxide Nickel	
Requirement set with Hazard Levels	R26	



Specifications and approvals

Specifications	IEC 60603-2
UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079
Railway classification	F4/I3 acc. to NFF 16-101/102

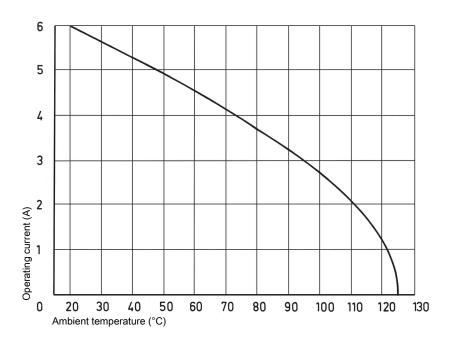
Commercial data

Packaging size	20	
Net weight	22.53 g	
Country of origin	Romania	
European customs tariff number	85366990	
GTIN	5713140009196	
eCl@ss	27460201 PCB connector (board connector)	

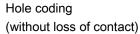
Current carrying capacity

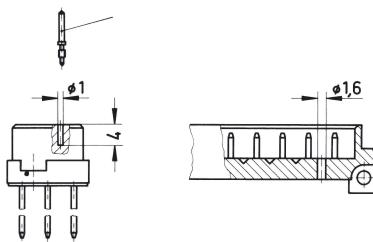
The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

Measuring and testing techniques acc. to IEC 60512-5-2









To avoid cross-plugging of adjacent connectors a coding system is required.

Drill out the male connector at pre-centered point according to the sketch. Use the setting tool 09 99 000 0103 to insert the coding pin 09 06 000 9950 into the existing hole in the female connector.

Coding with loss of contacts

To avoid cross-plugging of adjacent connectors a coding system is required.

The coding is achieved by means of a code pin which is inserted into the selected chamber of the female connector (the contact cavity must be filled with a female contact!).

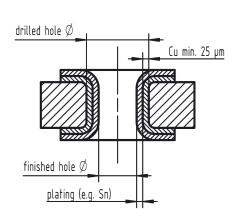
The opposite male contact must be removed with the help of the specially designed tool. It's recommended to use at least 3 pins.

Coding pin 09 04 000 9908

Removal tool for male contacts 09 99 000 0038



Recommended configuration of plated through holes



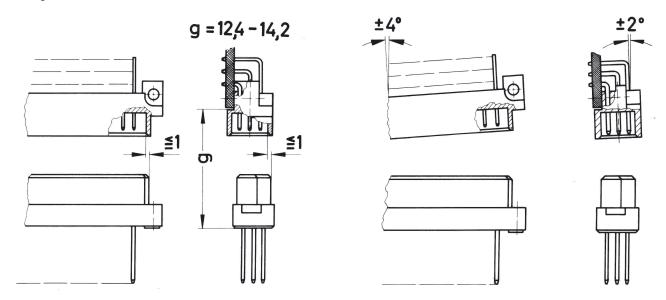
Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15±0,025 mm
	Sn	max. 15 µm
	plated hole Ø	0,94 - 1,09 mm
Chemical tin plated PCB	Drilled hole Ø	1,15±0,025 mm
	Sn	min. 0,8µm
	plated hole Ø	1,00 – 1,10 mm
Gold /Nickel plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ni	3 - 7 µm
	Au	0,05 - 0,12 µm
	plated hole Ø	1,00 - 1,10 mm
Silver plated PCB	Drilled hole Ø	1,15±0,025 mm
	Ag	0,1 - 0,3 µm
	plated hole Ø	1,00 – 1,10 mm
Copper plated PCB (OSP)	Drilled hole Ø	1,15±0,025 mm
	plated hole Ø	1,00 – 1,10 mm

In addition to the hot-air-level (HAL) other pcb surfaces are getting more important. Due to their different properties, such as mechanical strength and coefficient of friction we recommend the above mentioned configuration of pcb through holes.

Assembly instructions

It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information for the press-in process.

Mating conditions



To ensure reliable connections and prevent unnecessary damage, please refer to the application data diagrams. These recommendations are set out in IEC 60603-2.

The connectors should not be coupled and decoupled under electrical load.